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YDS-ENT-IMX214 V2.2 13MP Sony IMX214 MIPI Interface Auto Focus Camera Module





Front View Back View

Specifications

Camera Module No.	YDS-ENT-IMX214 V2.2		
Resolution	13MP		
Image Sensor	IMX214 w/ Blue Film		
Sensor Type	1/3.06"		
Pixel Size	1.12 um x 1.12 um		
EFL	2.80 mm		
F.NO	1.90		
Pixel	4224 x 3136		
View Angle	90.3°(DFOV) 77.4°(HFOV) 62.0°(VFOV)		
Lens Dimensions	8.50 x 8.50 x 5.35 mm		
Module Size	16.07 x 9.00 mm		
Module Type	Auto Focus		
Interface	MIPI		
Auto Focus VCM Driver IC	FP5510		
Lens Model	YDS-LENS-50156A1-00		
Lens Type	650nm IR Cut		
Operating Temperature	-20°C to +70°C		
Mating Connector	BM20B(0.8)-30DS-0.4V(51)		



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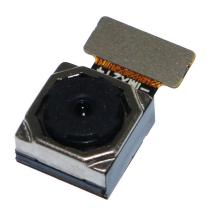
YDS-ENT-IMX214 V2.2 13MP Sony IMX214 MIPI Interface Auto Focus Camera Module







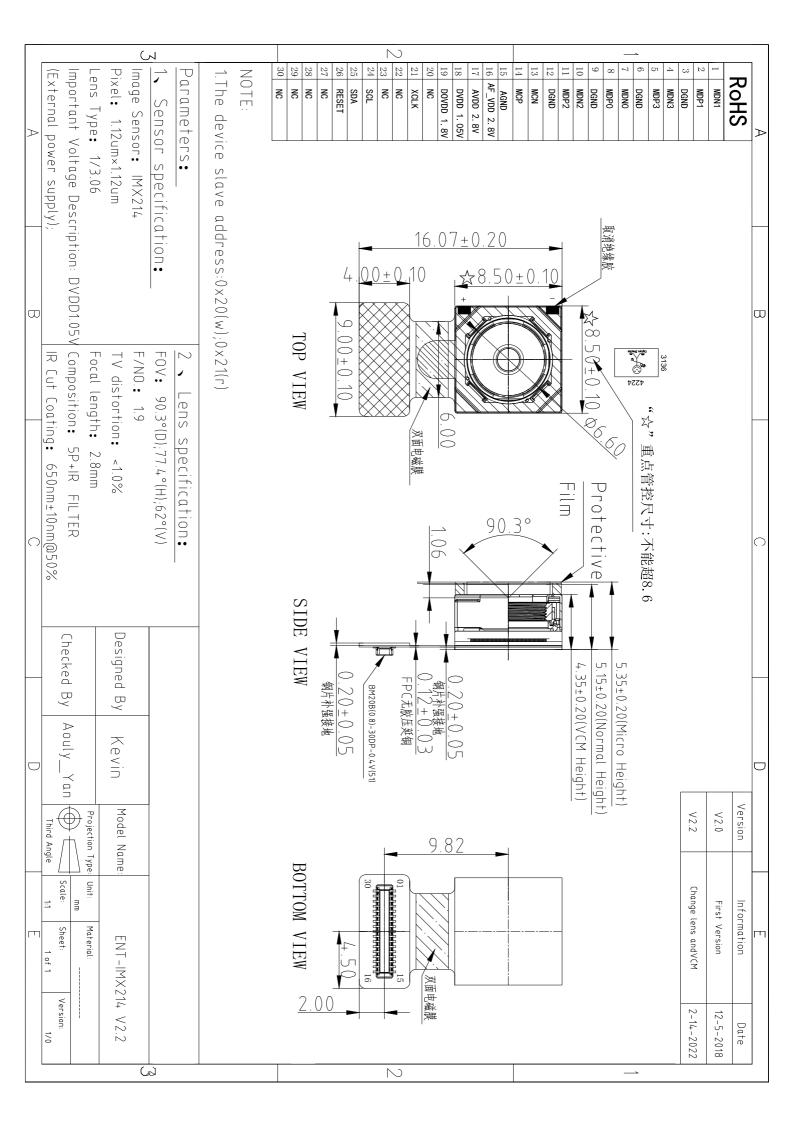
Side View



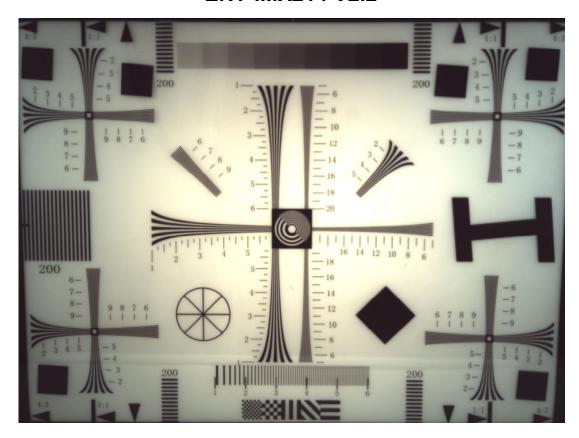
Bottom View

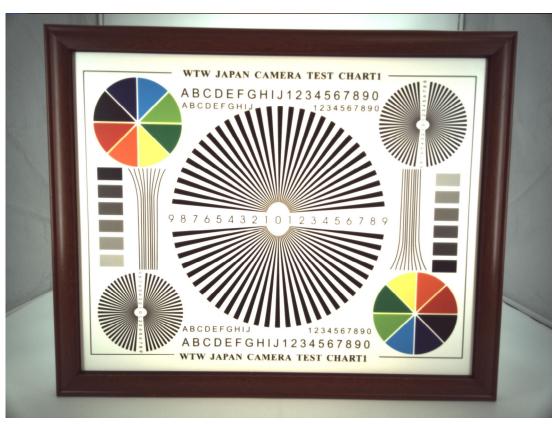


Mating Connector

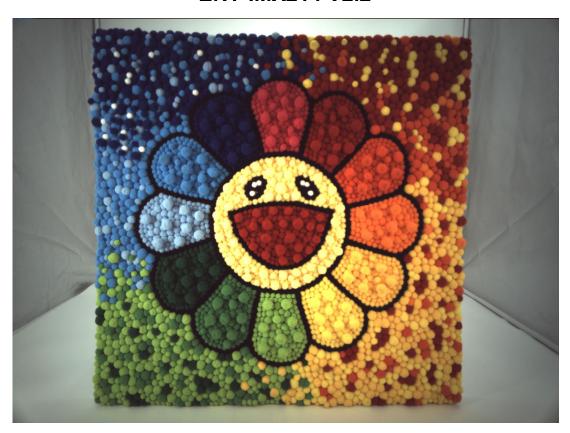


Real Test Images ENT-IMX214 V2.2





Real Test Images ENT-IMX214 V2.2

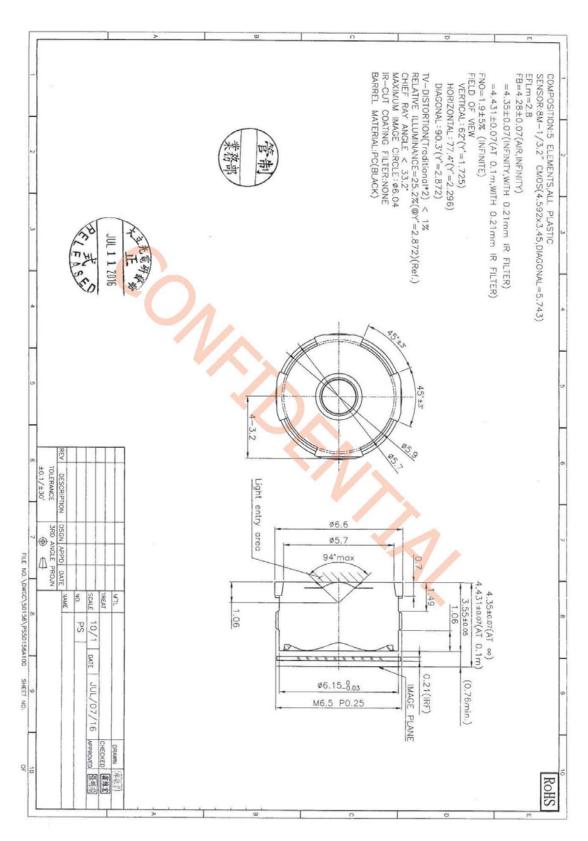






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Lens Model: KLT-LENS-50156A1-00





10-Bit DAC 120mA VCM Driver with I²C Interface

Description

The FP5510 is a single 10-bit DAC with 120mA output current voice coil motor (VCM) driver, with an I^2 C-compatible serial interface that operates at clock rates up to 400kHz. Its supply operates from 2.3V to 3.6V.

The FP5510 incorporates with a power-on reset circuit, power-down function. Power-on reset circuit ensure when supply power up, DAC output is to 0V until valid write bit value takes place. In power down mode, the supply current is about 1µA.

The FP5510 is designed for auto focus operation includes digital camera module, optical zoom camera phones and lens auto focus. The I²C address of FP5510 is 0x18h.

The FP5510 with WLCSP package which it is suitable for reduced-space mounting in mobile phone and other portable applications.

Pin Assignments

6-Ball WLCSP

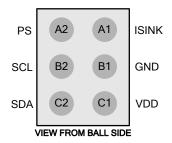


Figure 1. Pin Assignment of FP5510

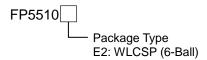
Features

- Power Supply Voltage Rang: 2.3V to 3.6V
- VCM Driver for Auto-Focus
- 10-Bit Resolution Current Sinking of 120mA for VCM
- 2-Wire I²C Interface (1.8V Interface Compatible)
- Internal 4 Slope Control Mechanism
- 1. Enhance Slope Control Mode
 - 2. One Step Mode
- 3. Linear Slope Mode
- 4. Two Step Slope Mode
- Power-Save Mode Current < 1µA
- Power On Reset (POR)
- Small Size: 0.7mm×1.1mm (6-Balls WLCSP)

Applications

- Digital Camera Module
- Cell Phone
- Lens Cover
- Web Camera

Ordering Information



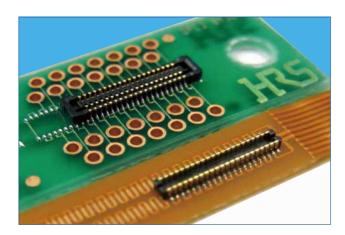
WLCSP-6 (0.7mmx1.1mm) Marking

Part Number	Product Code
FP5510E2	2

FP5510-1.0-SEP-2016 **1**

0.4mm Pitch, 0.6 and 0.8mm Height, Board-to-Board and Board-to-FPC Connectors

BM20 Series



■Features

1. High density mounting capability

A space saving design that keeps the connector compact, but still maintains an adequate vacuum area (no less than 0.7mm wide).

Depth DS: 2.3mm DP: 1.78mm

2. Reliable contact performance

Even though the mated height is low, the BM20 still leads it class in maximum effective mating lengths for each mating height.

<Effective Mating Length> Height 0.8mm: 0.2mm Height 0.6mm: 0.15mm

The addition of the two point contact system adds more reliability to the contacts.

3. No restrictions to PCB pattern design for the 0.8 mm height connector *1

This series utilizes a thin wall to insulate the bottom surface of the connector and maintains an effective mating length of 0.2mm. This removes any restriction for PCB pattern layout design under the connector.

Note *1: There are some restrictions for the 0.6 mm height style.

4. Enhanced mating operations

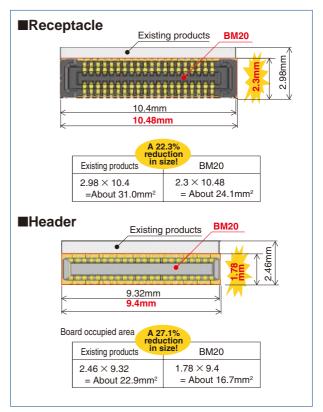
The structure uses guide ribs to ease the mating process and offers a self alignment range of up to 0.3mm. A clear tactile click is used as an indicator to the user that the mating process was completed.

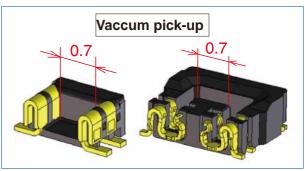
5. Drop and shock resistant structure

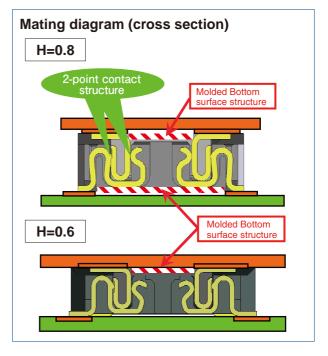
Dimples were designed into the contacts to increase their retention force and to absorb the shock delivered from a drop or other impact.

6. Debris resisting design

When mated, the connector's design covers the contacts which help to keep dust and other debris away from the contacts. The SMT leads are kept very close to the connector housing which also helps to prevent shorts caused by debris on the exposed contacts







■Product Specifications

Ratings	Rated Current	0.3A	Operating Temperature Range	- 35 ∼ 85°C (Note 1)	Storage Temperature Range	- 10 ∼ 60°C (Note 2)
	Rated Voltage	AC, DC 30V	Operating Humidity Range	20 ~ 80%	Storage Humidity Range	40 ~ 70% (Note 2)

Items	Specifications	Conditions
1. Insulation Resistance	Minimum of 50MΩ	Measured with DC 100V
2. Withstanding Voltage	No flashover or breakdown	Apply AC 100V for 1 minute
3. Contact Resistance	Maximum of 100mΩ	Measured with AC 20 mV, 1 kHz and 1 mA
4. Vibration Resistance	No electrical discontinuity of 1 μ s or greater	Frequency 10-55 Hz, half amplitude 0.75mm, 3 directions for 2 hours
5. Humidity Resistance	Contact resistance Maximum of $100m\Omega$ Insulation resistance Minimum of $25m\Omega$	Left at temperature 40±2°C, humidity 90 to 95%, 96 hours
6. Temperature Cycles	Contact resistance Maximum of 100mΩ Insulation resistance Minimum of 50mΩ	(-55°C : 30 minutes \rightarrow 5~35°C : 10 minutes \rightarrow 85°C : 30 minutes \rightarrow 5~35°C : 10 minutes) 5 cycles
7. Durability	Contact Resistance: maximum of 100mΩ	10 mating cycles
8. Soldering Heat Resistance	Should be no melting of resin parts that affects its performance	Reflow: according to the Recommended Solder Profile Hand solder: Soldering iron temperature 350°C, no more than 3 seconds.

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" here refers to products stored for a long period prior to board mounting and use. The operating temperature and humidity range covers the non-energized condition of connectors after board mounting and the temporary storage conditions during transportation, etc.

■Materials

Product	Component	Materials	Finish	UL Regulation
Receptacle	Insulator	LCP	Black	UL94V-0
Header	Contact	Phosphorous bronze	Gold plating	

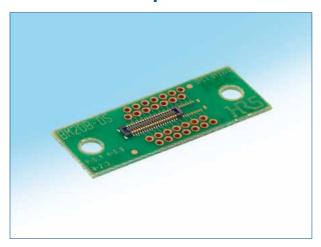
■Product Number Structure

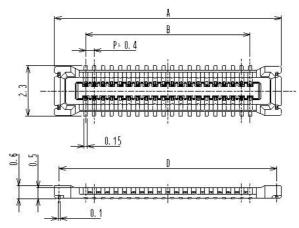
Refer to this page when determining product specifications by model types. Please place orders with part numbers listed in this catalog. The characteristics and specifications of the product described in this catalog are reference values. Please make sure to check the latest delivery specifications at the time of product use.

Receptacle/Header

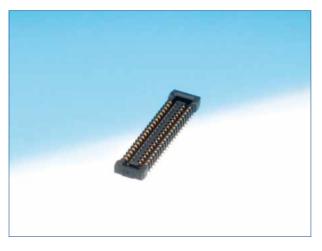
Series Name : BM	6 Connector Type
2 Series No. : 20	DS : Double row receptacle
3 Shape Symbols	DP : Double row header
B : With reinforcing metal fitting	7 Contact Pitch : 0.4mm
4 Stack height: 0.6mm, 0.8mm	Terminal Shape V : Vertical SMT
5 No. of Contacts : Please refer to page 3 and after.	Packaging (51): Embossed tape package (8,000 pieces per reel)

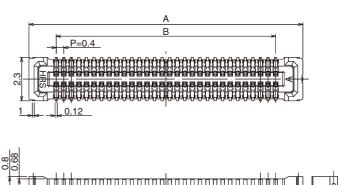
■H=0.6mm receptacle



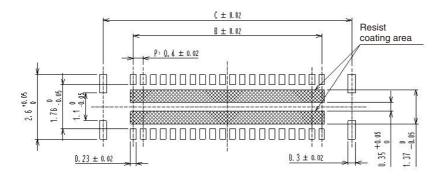


■H=0.8mm receptacle

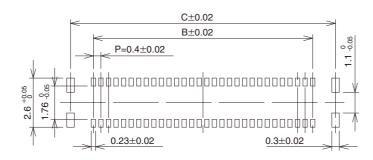




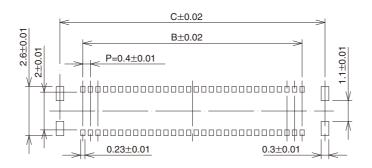




♠ Recommended PCB layout [H= 0.8mm]



♠Recommended metal mask size (Mask thickness 100 µm) [0.6 mm and 0.8 mm common]



Unit: mm

Part No.	HRS No.	No. of Contacts	А	В	С	D
BM20B(0.6)-10DS-0.4V(51)	0684-9308-8 51	10	4.48	1.6	4.02	4.06
BM20B(0.6)-20DS-0.4V(51)	0684-9309-0 51	20	6.48	3.6	6.02	6.06
BM20B(0.6)-24DS-0.4V(51)	0684-9310-0 51	24	7.28	4.4	6.82	6.86
BM20B(0.6)-30DS-0.4V(51)	0684-9311-2 51	30	8.48	5.6	8.02	8.06
BM20B(0.6)-34DS-0.4V(51)	0684-9312-5 51	34	9.28	6.4	8.82	8.86
BM20B(0.6)-40DS-0.4V(51)	0684-9313-8 51	40	10.48	7.6	10.02	10.06
BM20B(0.6)-50DS-0.4V(51)	0684-9314-0 51	50	12.48	9.6	12.02	12.06
BM20B(0.6)-60DS-0.4V(51)	0684-9315-3 51	60	14.48	11.6	14.02	14.06

Part No.	HRS No.	No. of Contacts	Α	В	C
BM20B(0.8)-10DS-0.4V(51)	0684-9008-4 51	10	4.48	1.6	4.02
BM20B(0.8)-16DS-0.4V(51)	0684-9041-0 51	16	5.68	2.8	5.22
BM20B(0.8)-20DS-0.4V(51)	0684-9009-7 51	20	6.48	3.6	6.02
BM20B(0.8)-24DS-0.4V(51)	0684-9010-6 51	24	7.28	4.4	6.82
BM20B(0.8)-30DS-0.4V(51)	0684-9011-9 51	30	8.48	5.6	8.02
BM20B(0.8)-34DS-0.4V(51)	0684-9020-0 51	34	9.28	6.4	8.82
BM20B(0.8)-40DS-0.4V(51)	0684-9012-1 51	40	10.48	7.6	10.02
BM20B(0.8)-50DS-0.4V(51)	0684-9013-4 51	50	12.48	9.6	12.02

Note 1: This product is sold by full reel quantities of 8,000 pieces per reel. Please place orders in full reel quantities.

Note 2: This connector is NOT polarized.

SONY

[Product Brief]

Ver.1.0

IMX214

Diagonal 5.867mm (Type 1/3.06) 13M Pixel CMOS Image Sensor with Square Pixel for Color Cameras

Description

IMX214 is a diagonal 5.867mm(Type 1/3.06) 13M pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor RS[™] technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. By introducing spacially varying exposure technology, high dynamic range still pictures and movies are achievable. It equips an electronic shutter with variable integration time. It operates with three power supply voltages: analog 2.7 V, digital 1.0V and 1.8 V for input/output interface and achieves low power consumption. IMX214 is designed for use in cellular phones or tablet devices*.

Functions and Features

- ◆ Back illuminated and stacked CMOS image sensor Exmor RS
- ◆ Single Frame High Dynamic Range (HDR) with equivalent full pixels.
- ♦ High signal to noise ratio (SNR).
- ◆ Full resolution @30fps (Nornmal / HDR).4K2K @30fps (Normal / HDR)1080p @60fps (Normal / HDR)
- ◆ Output video format of RAW10/8, COMP8/6
- ◆ Pixel binning readout and H/V sub sampling function
- ◆ Advanced Noise Reduction (Chroma noise reduction and luminance noise reduction)
- Independent flipping and mirroring.
- ◆ CSI 2 serial data output (MIPI 2lane/4lane, Max. 1.2Gbps/lane, DPHY spec. ver. 1.1 compliant)
- ◆ 2wire serial communication
- ◆ Two PLLs for independent clock generation for pixel control and data output interface.
- Advanced Noise Reduction.
- ◆ Dynamic Defect Pixel Correction.
- Zero shutter lag.
- Power on reset function
- Dual sensor synchronization operation.
- ◆8K bit of OTP ROM for users.
- Built in temperature sensor

NOTE)

1. When using this product for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and Tablet PCs. Consult your Sony sales representative if you have any questions.

SONY IMX214

Device Structure

◆ CMOS image sensor

♦ Image size : Diagonal 5.867mm (Type 1/3.06)

◆ Total number of pixels
 ♦ Number of effective pixels
 ♦ Number of active pixels
 14224 (H) ×3200(V) approx. 13.51M pixels
 14224 (H) ×3136 (V)approx. 13.25 M pixels
 14208 (H) ×3120 (V) approx. 13.13 M pixels

♦ Chip size : 6.100mm (H) × 4.524mm (V) ♦ Unit cell size : 1.12 μm (H) × 1.12 μm (V)

◆ Substrate material : Silicon

Functional Description

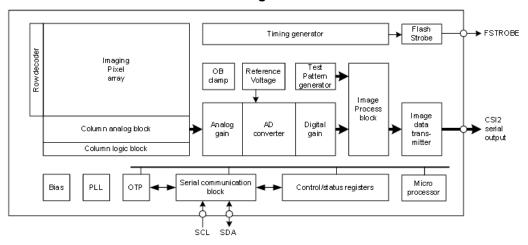
System Outline

IMX214 is a CMOS active pixel type image sensor which adopts the Exmor RS [™] technology to achieve high sensitivity, low noise and high speed image capturing. It is embedded with backside illuminated imaging pixel, low noise analog amplifier,

column parallel A/D converters which enables high speed capturing, digital amplifier, image binning circuit, timing control circuit for imaging size and frame rate, CSI2 image data high speed serial interface, PLL oscillator, and serial communication interface to control these functions.

Several additional image processing functions and peripheral circuits are also included for easy system optimization by the users. A one time programmable memory is embedded in the chip for storing the user data. It has 8 K-bit for users, 10 K-bit as a whole.

Block Diagram



Exmor RS

* Exmor RS is a trademark of Sony Corporation. The Exmor RS is a Sony's CMOS image sensor with high-resolution, high-performance and compact size by replacing a supporting substrate in Exmor RTM which changed fundamental structure of ExmorTM pixel adopted column parallel A/D converter to back-illuminated type, with layered chips formed signal processing circuits.

Sony reserves the right to change products and specifications without prior notice.

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Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.



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Cameras Applications





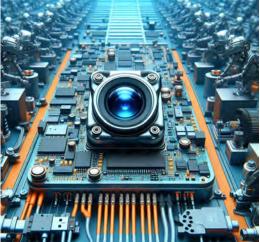


Automotive Driver Pilot

Live Streaming

Video Conference







Eye Tracker Biometric Detection

Machine Vision

Agricultural Monitor







Night Vision Security

Drone and Sports Eagle Eyes

Interactive Pet Camera



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Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors				
Pin Signal	Description			
DGND GND	ground for digital circuit			
AGND	ground for analog circuit			
PCLK DCK	DVP PCLK output			
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor			
MCLK XVCLK XCLK INCK	system input clock			
RESET RST	reset active low with internal pull-up resistor			
NC NULL	no connect			
SDA SIO_D SIOD	SCCB data			
SCL SIO_C SIOC	SCCB input clock			
VSYNC XVS FSYNC	DVP VSYNC output			
HREF XHS	DVP HREF output			
DOVDD	power for I/O circuit			
AFVDD	power for VCM circuit			
AVDD	power for analog circuit			
DVDD	power for digital circuit			
STROBE FSTROBE	strobe output			
FSIN	synchronize the VSYNC signal from the other sensor			
SID	SCCB last bit ID input			
ILPWM	mechanical shutter output indicator			
FREX	frame exposure / mechanical shutter			
GPIO	general purpose inputs			
SLASEL	I2C slave address select			
AFEN	CEN chip enable active high on VCM driver IC			
MIPI Interface	3			
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output			
MDP0 DP0 MD0P DATA P DMO1P	MIPI 1st data lane positive output			
MDN1 DN1 MD1N DATA2 N DMO2N	MIPI 2nd data lane negative output			
MDP1 DP1 MD1P DATA2 P DMO2P	MIPI 2nd data lane positive output			
MDN2 DN2 MD2N DATA3 N DMO3N	MIPI 3rd data lane negative output			
MDP2 DP2 MD2P DATA3 P DMO3P	MIPI 3rd data lane positive output			
MDN3 DN3 MD3N DATA4 N DMO4N	MIPI 4th data lane negative output			
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output			
MCN CLKN CLK_N DCKN	MIPI clock negative output			
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output			
DVP Parallel Interface				
D0 D00 Y0	DVP data output port 0			
D1 D01 Y1	DVP data output port 1			
D2 DO2 Y2	DVP data output port 2			
D3 DO3 Y3	DVP data output port 3			
D4 DO4 Y4	DVP data output port 4			
D5 DO5 Y5	DVP data output port 5			
D6 D06 Y6	DVP data output port 6			
D7 D07 Y7	DVP data output port 7			
D8 DO8 Y8	DVP data output port 8			
D9 DO9 Y9	DVP data output port 9			
D10 DO10 Y10	DVP data output port 10			
D11 D011 Y11	DVP data output port 11			
ווו ווטס ווס	DVI data output port 11			



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Camera Reliability Test

Reliability Inspection Item			Tanking Makhad	Acceptance Critoria	
Cat	egory	Item	Testing Method	Acceptance Criteria	
	Storage	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Temperature	Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation	
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation	
	Drop Test	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
	(Free Falling)	With Package 60cm	10 Times on Wood Floor	Electrically Functional	
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
Tilysical		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
Cable Tensile Strength Test		Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional	
	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
	ESD Test	Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
Electrical	Aging Test On/Off 30 Seconds Cycling in 24 Hours		Power Switch	Electrically Functional	
USB Connector O		On/Off 250 Times	Plug and Unplug	Electrically Functional	











Camera Inspection Standard

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Inspection Item		ı Item	Lancar Cara Madhad	Ota a land of languages
Cate	gory	Item	Inspection Method	Standard of Inspection
		Color	The Naked Eye	Major Difference is Not Allowed.
	FPC/ PCB	Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
		Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Holder	Gap	The Naked Eye	Meet the Height Standard
Appearance	Holdel	Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
		Scratch	The Naked Eye	No Effect On Resolution Standard
	Long	Contamination	The Naked Eye	No Effect On Resolution Standard
	Lens	Oil Film	The Naked Eye	No Effect On Resolution Standard
		Cover Tape	The Naked Eye	No Issue On Appearance.
		No Communication	Test Board	Not Allowed
		Bright Pixel	Black Board	Not Allowed In the Image Center
		Dark Pixel	White board	Not Allowed In the Image Center
		Blurry	The Naked Eye	Not Allowed
		No Image	The Naked Eye	Not Allowed
		Vertical Line	The Naked Eye	Not Allowed
		Horizontal Line	The Naked Eye	Not Allowed
Function	Image	Light Leakage	The Naked Eye	Not Allowed
		Blinking Image	The Naked Eye	Not Allowed
		Bruise	Inspection Jig	Not Allowed
		Resolution	Chart	Follows Outgoing Inspection Chart Standard
		Color	The Naked Eye	No Issue
		Noise	The Naked Eye	Not Allowed
		Corner Dark	The Naked Eye	Less Than 100px By 100px
		Color Resolution	The Naked Eye	No Issue
		Height	The Naked Eye	Follows Approval Data Sheet
Dimer	neion	Width	The Naked Eye	Follows Approval Data Sheet
Dilliel	131011	Length	The Naked Eye	Follows Approval Data Sheet
		Overall	The Naked Eye	Follows Approval Data Sheet



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YDSCAM Package Solutions

YDS Camera Module



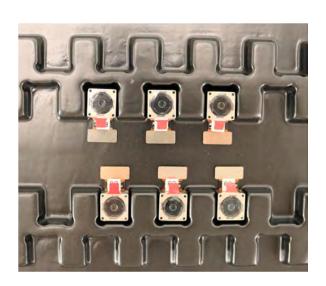
Tray with Grid and Space



Complete with Lens Protection Film



Place Cameras on the Tray

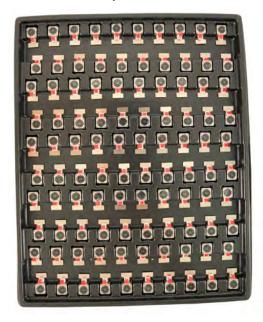




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YDSCAM Package Solutions

Full Tray of Cameras



Place Tray into Anti-Static Bag



Cover Tray with Lid



Vacuum the Anti-Static Bag





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YDSCAM Package Solutions

Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution





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YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags



Place Foam Sheets and Trays into Box



Seal the Carbon Box



Foam Sheets are Larger Than Trays



Foam Sheets are Tightly Fitting in Box



Label the Carbon Shipping Box





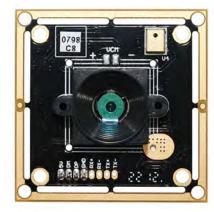
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YDSCAM Package Solutions

USB Camera Module

Complete with Lens Protection Film







Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray







Seal the Tray with Anti-Static Bag

Label the Carbon Shipping Box







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YDSCAM Package Solutions

Place Camera Sample into Anti-Static Bag





Label the Sample Bags



Place Samples into the Carbon Box



Place Connectors into Anti-Static Bag





Place Connectors into Reel



Place Connectors into the Carbon Box





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Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.





Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website www.YDSCAM.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequential events.















your best camera partner

YDS Strength

Powerful Factory





Professional Service







Promised Delivery











